

# 0.5W Zener Diode - BZX55A\* series

**Rev 1.0** 

0.5W 5mA I<sub>ZT</sub> Silicon Planar Zener diode in bare die form – 1% tolerance, "A" grade 07/04/19

#### Features:

- Tight tolerance reverse breakdown voltage
- I<sub>R</sub> characterized at 125°C
- Sharp reverse characteristics
- Low reverse current Levels
- High reliability gold back metal

### **Ordering Information**

The following part suffixes apply:

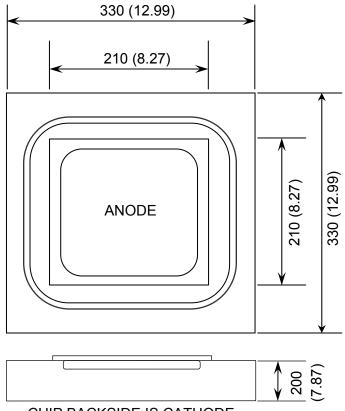
- No suffix MIL-STD-750 /2073 Visual Inspection
- "H" MIL-STD-750 /2073 Visual Inspection+ MIL-PRF-38534 Class H LAT
- "K" MIL-STD-750 /2073 Visual Inspection+ MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

For further information on LAT process flows see below.

www.siliconsupplies.com\quality\bare-die-lot-qualification

### Die Dimensions in µm (mils)



CHIP BACKSIDE IS CATHODE

### **Supply Formats:**

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape By specific request
- Unsawn Wafer By specific request
- Lower precision V<sub>Z</sub> tolerances:

2% - B grade, 5% - C grade

### **Mechanical Specification**

Die Size (Unsawn)	330 x 330 12.99 x 12.99	μm mils		
Anode Pad Size	210 x 210 8.27 x 8.27	μm mils		
Die Thickness	200 7.87	μm mils		
Top Metal Composition	Al			
Back Metal Composition	Au			





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## Absolute Maximum Ratings<sup>1</sup> T<sub>A</sub> = 25°C unless otherwise stated

PARAMETER	SYMBOL	VALUE	UNIT
Power Dissipation <sup>2</sup>	P <sub>TOT</sub>	500	mW
Junction Temperature	TJ	200	°C
Storage Temperature Range	Ts	-65 to +200	°C
Forward Voltage @ I <sub>F</sub> = 100mA	V <sub>F</sub>	1	V

### Electrical Characteristics T<sub>A</sub> = 25°C unless otherwise stated

DEVICE	ZENER VOLTAGE RANGE		TEST CURRENT REVE		REVERSE LI	EAKAGE CURI	DYNAMIC RESISTANCE			
						I <sub>R</sub> @ V <sub>R</sub>		Z <sub>Z</sub> @ I <sub>ZT1</sub>	Z <sub>ZK</sub> @ I <sub>ZT2</sub>	
	Vz @ I <sub>ZT1</sub>		I <sub>ZT1</sub> I <sub>ZT2</sub>	I <sub>ZT2</sub>	T <sub>A</sub> = 25°C	T <sub>A</sub> = 125°C		f = 1 kHz		
	V		mΛ		μΑ Max.		V	Ω		
	Min.	Nom.	Max.	mA		μΑ Wax.		V	Max.	Max.
BZX55A2V4	2.376	2.4	2.424	5	1	50.0	100	1.0	85	600
BZX55A2V7	2.673	2.7	2.727	5	1	10.0	50	1.0	85	600
BZX55A3V0	2.97	3.0	3.03	5	1	4.0	40	1.0	85	600
BZX55A3V3	3.267	3.3	3.333	5	1	2.0	40	1.0	85	600
BZX55A3V6	3.564	3.6	3.636	5	1	2.0	40	1.0	85	600
BZX55A3V9	3.861	3.9	3.939	5	1	2.0	40	1.0	85	600
BZX55A4V3	4.257	4.3	4.343	5	1	1.0	20	1.0	75	600
BZX55A4V7	4.653	4.7	4.747	5	1	0.5	10	1.0	60	600
BZX55A5V1	5.049	5.1	5.151	5	1	0.1	2.0	1.0	35	550
BZX55A5V6	5.544	5.6	5.656	5	1	0.1	2.0	1.0	25	450
BZX55A6V2	6.138	6.2	6.262	5	1	0.1	2.0	2.0	10	200
BZX55A6V8	6.732	6.8	6.868	5	1	0.1	2.0	3.0	8.0	150
BZX55A7V5	7.425	7.5	7.575	5	1	0.1	2.0	5.0	7.0	50
BZX55A8V2	8.118	8.2	8.282	5	1	0.1	2.0	6.2	7.0	50
BZX55A9V1	9.009	9.1	9.191	5	1	0.1	2.0	6.8	10	50

<sup>1.</sup> Operation above the absolute maximum rating may cause device failure. Operation at the absolute maximum ratings, for extended periods, may reduce device reliability.

Zener Voltages 10V to 75V are constructed using a larger die geometry.

Please see here for further details



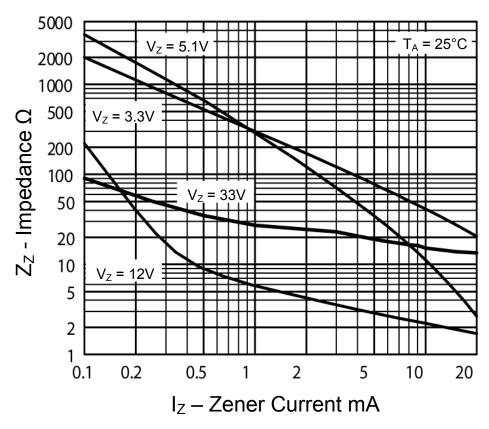
<sup>2.</sup> Assembled in DO-35 package. Performance in die form subject to assembly heat sinking and die attach methods.



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### **Typical Electrical Characteristics**



Zener Impedance Versus Operating Current - Zz Versus Iz

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